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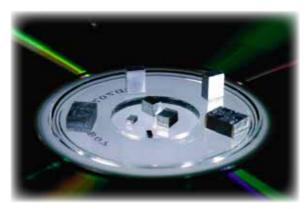
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







Stable Stacked Metallized Film (PPS) Chips for Reflow Soldering



The Type FCP's combination of high capacitance density and excellent high frequency response makes it a great choice for wireless and instrumentation applications.

Type FCP stacked metallized polyphenelene sulfide (PPS) film capacitors offer high capacitance per unit volume, stable capacitance and DF over a wide temperature range, and excellent high frequency performance. Type FCP capacitors conform to standard EIA 0603, 0805, 1206, 1210, 1913 & 2416 surface mount case sizes and are packaged on tape and reel.

Highlights

- Stacked metallized polyphenylene sulfide (PPS) film.
- High operating temperature to +125 °C
- High capacitance per unit volume
- Excellent high frequency performance
- Typical Δ C from −55 °C to 105 °C ≤ ±1.5%
- Stable cap and DF over wide temperature range

Specifications

Capacitance Range	100 pF to 0.22 μF (1kHz at ≤5 Vrms)
Capacitance Tolerance	±5% (J) Standard, ±2% (G) Optional
Rated Voltage	16 Vdc and 50 Vdc
Dissipation Factor (Tan δ)	0.6% Max. (1 kHz at ≤5 Vrms)
Operating Temperature Range	-55 °C to $+125$ °C (See Voltage derating chart for 0.12 - 0.22 μF above 105 °C)
Dielectric Strength	150% of rated Vdc for 60 s
Insulation Resistance	3000 MΩ Min. at 20 °C, after 60 s (16 Vdc rated, test 10 Vdc; 50 Vdc rated, test 50 Vdc)
Construction	Stacked metallized polyphenylene sulfide (PPS) film. Terminations are lead free with a Sn-Ag-Cu solder finish.
Life Test	Capacitors subjected to 1000 hours of maximum rated temperature and 125% of the rated voltage will not have any significant visual damage, the capacitance will be within $\pm 2\%$ of the initial measured value, DF will be a maximum of 0.66%, and IR will be a minimum of 1000 Megohms.
Resistance to Soldering Heat	Capacitors subjected to a maximum of 260 °C reflow soldering process will not have any significant visual damage, the dielectric strength will be as specified, the capacitance will be within ±3% of the initial measured value, DF will be a maximum of .66%, and IR will be a minimum of 1000 Megohms.
Moisture Resistance	Capacitors subjected to 1000 h at 40 °C and 90% to 95% RH and rated voltage will not have any significant visual damage, will withstand 1.3 times the rated voltage for one minute, the capacitance will be within ±2% of the initial measured value, DF will be a maximum of 0.9%, and IR will be a minimum of 1000 Megohms.
	RoHS Compliant

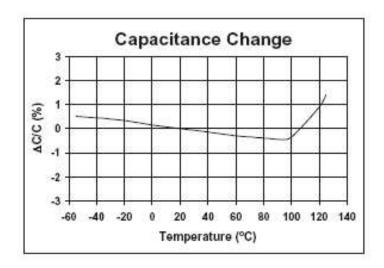
Stable Stacked Metallized Film (PPS) Chips for Reflow Soldering Ratings

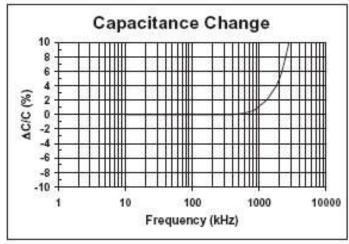
	50 Vdc		16 Vdc	Capacitance		
Case	Catalog	Case	Catalog	(-)	(=)	(=)
Code	Part Number	Code	Part Number	(pF)	(nF)	(μ F)
	FCP0805H101J-J1		FCP0603C101J-K1	100	.10	.00010
-	FCP0805H121J-J1		FCP0603C121J-K1	120	.12	.00012
	FCP0805H151J-J1		FCP0603C151J-K1	150	.15	.00015
	FCP0805H181J-J1	1 -	FCP0603C181J-K1	180	.18	.00018
	FCP0805H221J-J1		FCP0603C221J-K1	220	.22	.00022
	FCP0805H271J-J1		FCP0603C271J-K1	270	.27	.00027
	FCP0805H331J-J1	1	FCP0603C331J-K1	330	.33	.00033
	FCP0805H391J-J1		FCP0603C391J-K1	390	.39	.00039
	FCP0805H471J-J1		FCP0603C471J-K1	470	.47	.00047
0805	FCP0805H561J-J1	0603	FCP0603C561J-K1	560	.56	.00056
	FCP0805H681J-J1		FCP0603C681J-K1	680	.68	.00068
	FCP0805H821J-J1		FCP0603C821J-K1	820	.82	.00082
	FCP0805H102J-J1	1	FCP0603C102J-K1	1000	1.00	.0010
	FCP0805H122J-J1		FCP0603C122J-K1	1200	1.20	.0012
	FCP0805H152J-J1		FCP0603C152J-K1	1500	1.50	.0015
	FCP0805H182J-J1	1	FCP0603C182J-K1	1800	1.80	.0018
	FCP0805H222J-J1		FCP0603C222J-K1	2200	2.20	.0022
	FCP0805H272J-J1		FCP0603C272J-K1	2700	2.70	.0027
	FCP1206H332J-H1		FCP0805C332J-J1	3300	3.30	.0033
1206	FCP1206H392J-H1		FCP0805C392J-J1	3900	3.90	.0039
	FCP1206H472J-H1		FCP0805C472J-J1	4700	4.70	.0047
	FCP1206H562J-H1	805	FCP0805C562J-J1	5600	5.60	.0056
	FCP1206H682J-H1		FCP0805C682J-J1	6800	6.80	.0068
	FCP1206H822J-H2		FCP0805C822J-J2	8200	8.20	.0082
	FCP1206H103J-H2		FCP0805C103J-J2	10000	10	.010
	FCP1210H123J-G1		FCP1206C123J-H1	12000	12	.012
	FCP1210H153J-G1		FCP1206C153J-H1	15000	15	.015
	FCP1210H183J-G2		FCP1206C183J-H1	18000	18	.018
1210	FCP1210H223J-G2	1 [FCP1206C223J-H1	22000	22	.022
	FCP1210H273J-G2	1206	FCP1206C273J-H2	27000	27	.027
	FCP1210H333J-G3		FCP1206C333J-H2	33000	33	.033
	FCP1210H393J-G3	1	FCP1206C393J-H3	39000	39	.039
	FCP1913H473J-E1		FCP1206C473J-H3	47000	47	.047
	FCP1913H563J-E1		FCP1210C563J-G2	56000	56	.056
1913	FCP1913H683J-E1		FCP1210C683J-G2	68000	68	.068
	FCP1913H823J-E2	1210	FCP1210C823J-G3	82000	82	.082
	FCP1913H104J-E2		FCP1210C104J-G3	100000	100	.100
†	FCP2416H124J-D1			120000	120	.12
	FCP2416H154J-D1			150000	150	.15
2416	FCP2416H184J-D3			180000	180	.18
	FCP2416H224J-D4			220000	220	.22

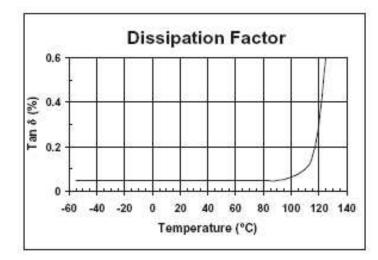
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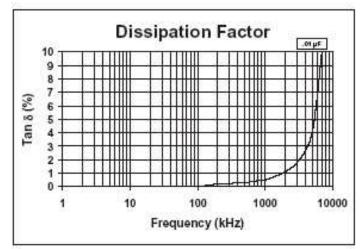
Typical Temperature Characteristics

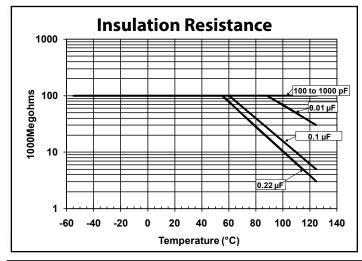
Typical Frequency Characteristics

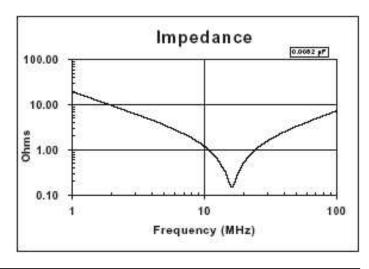






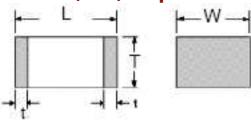




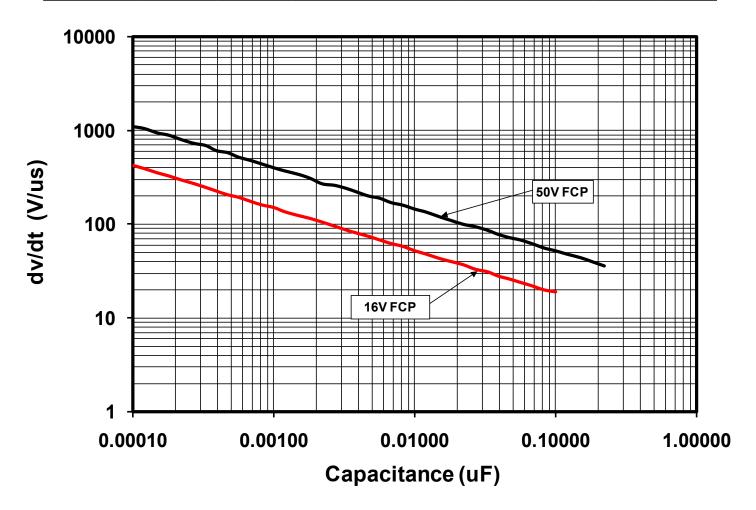


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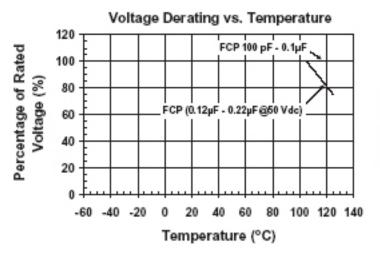
Outline Dimensions



Case Code	Outline Dimensions (in.)			Case Code	Outline Dimensions (mm)				Packaging	
	L ±0.008	W	T±0.008	t	(metric)	L ±0.2	W	T±0.2	t	Code
0603	0.063	0.032±0.006	0.028±0.006	0.014±0.008	1608	1.6	0.80±0.15	0.70±0.15	0.35±0.2	K1
0805	0.079	0.049±0.008	0.035	0.018±0.010 2	2012	2.0	1.25±0.2	0.9	0.45±0.25	J1
0805 0.079	0.079	0.079 0.049±0.008	0.043		2012	2.0	1.23±0.2	1.1		J2
			0.035					0.9		H1
1206	0.126	0.063±0.008	0.043	0.026±0.012	3216	3.2	1.6±0.2	1.1	0.65±0.3	H2
			0.059					1.5		H3
		0.126 0.098±0.008	0.043	0.026±0.012	3225	3.2	2.5±0.2	1.1	0.65±0.3	G1
1210	1210 0.126		0.059					1.5		G2
			0.083					2.1		G3
1913 0.1	0.189	0.130±0.012	0.059	0.031±0.012 4833	4022	4833 4.8	3.3±0.3	1.5	0.80±0.3	E1
	0.169	0.130±0.012	0.083		4033			2.1		E2
			0.075					1.9		D1
2416	0.236	0.161±0.012	0.098	0.031±0.012	6041	6.0	4.1±0.3	2.5	0.80±0.3	D3
			0.110					2.8		D4

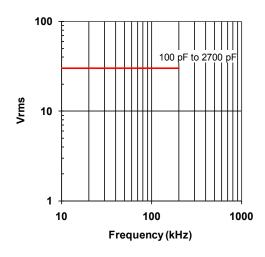


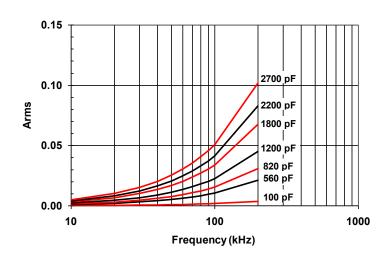
Stable Stacked Metallized Film (PPS) Chips for Reflow Soldering



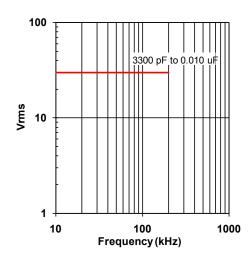
If the temperature on the surface of the capacitor is above 105°C, then the maximum voltage for FCP 50 Vdc ratings from .12 μF to .22μF must be derated linearly from full rated voltage at 105°C to 75% of the rated voltage at 125°C.

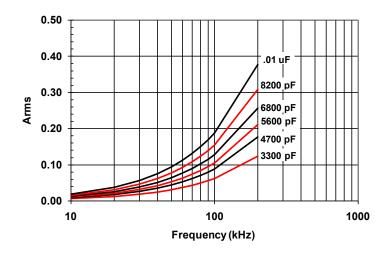
FCP 0805 50 Vdc Rating Vrms and Arms vs. Frequency





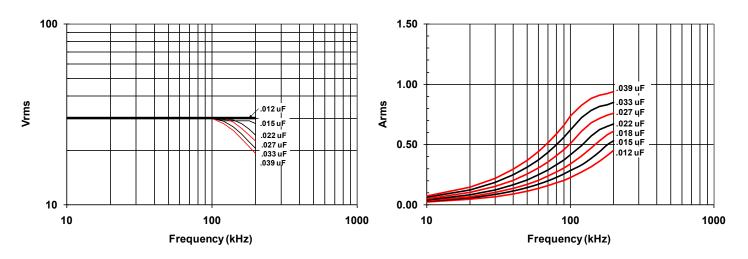
FCP 1206 50 Vdc Rating Vrms and Arms vs. Frequency



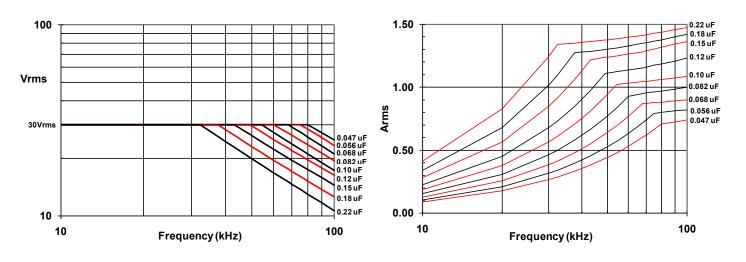


Stable Stacked Metallized Film (PPS) Chips for Reflow Soldering

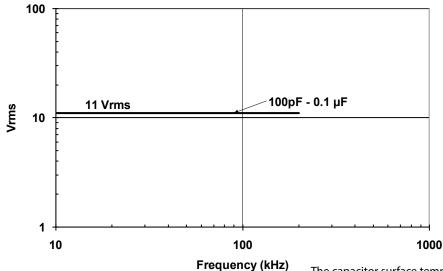
FCP 1210 50 Vdc Rating Vrms and Arms vs. Frequency



FCP 1913 & 2416 50 Vdc Rating Vrms and Arms vs. Frequency

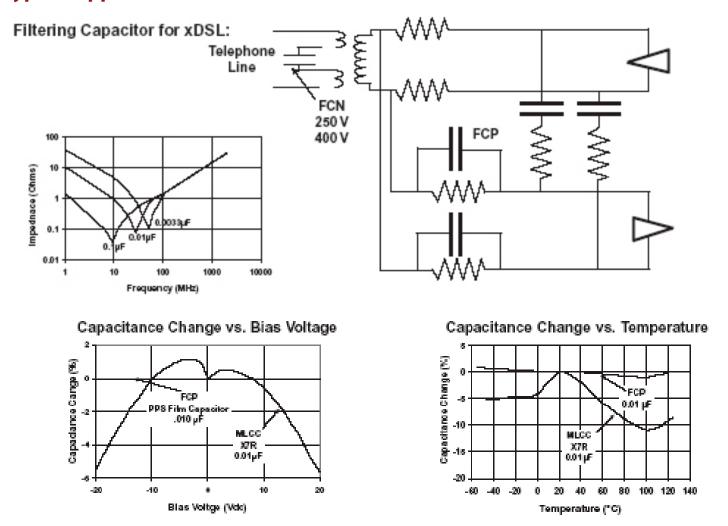


Maximum AC Voltage FCP 16Vdc Series



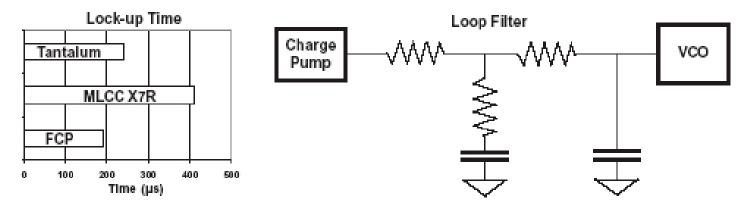
The capacitor surface temperature should not exceed 125 °C.

Stable Stacked Metallized Film (PPS) Chips for Reflow Soldering Typical Applications



The capacitance of SMT film chips is much more stable with applied voltage and with changes in temperature than multilayer ceramic capacitors. Add in the low ESR characteristics of film chips and the final result is improved performance in filter circuit applications.

PLL Circuit: Cellular phone, Blue Tooth, Data Communication Cards



In PLL circuit applications, FCP SMT film capacitor advantages are tight tolerance on the capacitance value, stable capacitance with temperature, faster lock-up times, and no noise due to piezoelectric effects.

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